	N CONNECTING CONVECTING INDUSTRIES	IPC, Bannockb	ourn, Illinois. A	Il rights reserved u ntions.	nder both	This docume level parts, t	ent is a declara he declaration	ation o 1 encor	of the substances mpasses all lowe	within th r level ma	e manufactur aterials for w	er listed i hich the n	tem. Note: nanufactur	: if the item is an as er has engineering	ssembly with lowe responsibility.
1752-21.1					Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information				
Supplie	r Information														
Company	name*	Company un	Company unique ID			Unique ID Authority					Response Date*				
onsemi												2025-08-28			
Contact N	lame		Title - Contact			]	Phone - Contact*					Email - Contact*			
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorize	ed Representative*		Title - Representative			]	Phone - Representative*				Email - Representative*				
Product-l	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item N   MC7905C		Number Mfr Item Name				Effective Da			uring Site	Weight*		UOM	Unit Type	
			CTG	G ANA 1A 5V NEGATIVE VREG			2025-08-28				1365.61	mg	Each		
/anufa	cturing Proccess Informa	ation												·	
	Terminal Plating / Grid Array Material		Cerminal Base Alloy J-STD-020 M		J-STD-020 MSI	L Rating	Peak Process Body Tempera		Body Temperatu	ure Max Time at Peak Ten		Temperat	ture Num	nber of Reflow Cy	cles
	Matte Tin (Sn) - annealed			CU Alloy NA			0 C 30				seconds 3				
omments	3														
or more	information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		mium (Cr6+), Polybrominated Biphenyls (Pl		dmium and quantity limit of 0.1% by mass (10 minated Diphenyl Ethers (PBDE), and Bis(2-et	
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).		
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the
Supplier Digital Signature	astislav Drska	Le			

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

sigma range of distribution unless otherwise noted).										
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure		
Die	1.61	mg	Supplier	Silicon (Si)	7440-21-3		1.61	mg		
Die Attach	0.21	mg	А	Lead (Pb)	7439-92-1	7a	0.189	mg		
			Supplier	Tin (Sn)	7440-31-5		0.021	mg		
Lead Frame	677.24	mg	Supplier	Silver (Ag)	7440-22-4		0.0339	mg		
			Supplier	Iron (Fe)	7439-89-6		0.6772	mg		
			Supplier	Copper (Cu)	7440-50-8		676.3054	mg		
			Supplier	Phosphorus (P)	7723-14-0		0.2235	mg		
Mold Compound-Black	644.0	mg		Metal Hydroxide	proprietary data		30.268	mg		
			Supplier	Carbon Black (C)	1333-86-4		1.932	mg		
			Supplier	Fused Silica (SiO2)	60676-86-0		515.2	mg		
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		64.4	mg		
			Supplier	Phenolic Resin (Novolac)	9003-35-4		32.1999	mg		
Plating	42.4	mg	Supplier	Tin (Sn)	7440-31-5		42.4	mg		
Wire Bond - Cu	0.15	mg	Supplier	Copper (Cu)	7440-50-8		0.15	mg		

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3